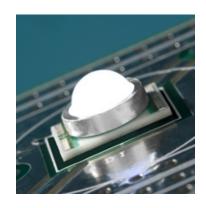


Cree® XLamp® XR-C LED Data Sheet

The XLamp XR-C LED gives lighting designers the flexibility and performance to create the next generation of LED lighting products. XLamp XR-C LEDs retain the industry-leading XLamp package characteristics, such as electrically neutral thermal path, reflow-solderable package, floating lens, and support for a wide range of drive currents.

Cree XLamp LEDs bring high performance and quality to many lighting applications, including portable lighting and flashlights, transportation, outdoor and industrial, signaling, architectural and entertainment/advertising installations.



FEATURES

- Full range of white: 2600 K to 10,000 K CCT
- Drive currents: 125 to 500 mA
- Low thermal resistance: 12°C/W
- Max junction temperature: 145°C
- Industry-leading JEDEC standard prequalification testing
- Reflow solderable JEDEC J-STD-020C compatible

- Electrically neutral thermal path
- RoHS-compliant
- Lumen maintenance of greater than 70% after 50,000 hours

Table of Contents

Flux Characteristics (T, = 25°C)	2
Characteristics	2
Relative Spectral Power	3
Photometric Output vs. Junction Temperature ($I_F = 350 \text{ mA}$)	
Electrical Characteristics (T ₁ = 25°C)	4
Thermal Design	4
Relative Intensity vs. Current (T, = 25°C)	5
Typical Spatial Radiation Pattern	5
Reflow Soldering Characteristics	6
Notes	7
Mechanical Dimensions (T _A = 25°C)	8
Tape and Reel	9
Dry Packaging and Packaging	



Flux Characteristics $(T_1 = 25^{\circ}C)$

The following tables describe the available colors and flux for XR-C LEDs by listing the correlated color temperature range for the entire family and by providing several base order codes. It is important to note that the base order codes listed here are a subset of the total available order codes for the product family. For more order codes, as well as a complete description of the order-code nomenclature, please consult the XR-E & XR-C Binning and Labeling document.

Color	CCT Range		Base Order Codes Min Luminous Flux (Im)		Order Code	
	Min.	Max.	Group	Flux (lm)		
Cool White	5,000 K	0 K 10,000 K	М3	45.7	XRCWHT-L1-0000-00301	
			N2	51.7	XRCWHT-L1-0000-00401	
			N3	56.8	XRCWHT-L1-0000-00501	
			N4	62.0	XRCWHT-L1-0000-00601	
			P2	67.2	XRCWHT-L1-0000-00701	
		5,000 K	М3	45.7	XRCWHT-L1-0000-003E4	
Neutral White	3,700 K		N2	51.7	XRCWHT-L1-0000-004E4	
			N3	56.8	XRCWHT-L1-0000-005E4	
Warm White	2,600 K	3,700 K	M2	39.8	XRCWHT-L1-0000-002E7	
			М3	45.7	XRCWHT-L1-0000-003E7	

Notes:

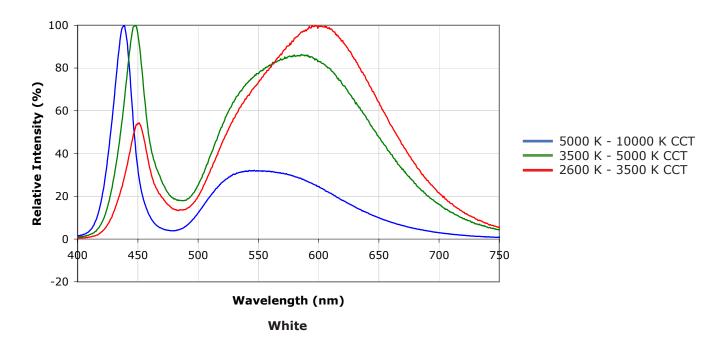
- Cree maintains a tolerance of +/- 7% on flux and power measurements.
- Typical CRI for Cool White & Neutral White (3,700 K 10,000 K CCT) is 75.
- Typical CRI for Warm White (2,600 K 3,700 K CCT) is 80.

Characteristics

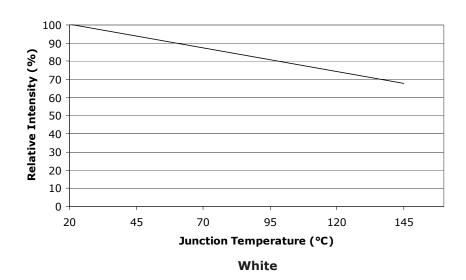
Characteristics	Unit	Minimum	Typical	Maximum
Thermal Resistance, junction to solder point	°C/W		12	
Viewing Angle (FWHM)	degrees		90	
Temperature coefficient of voltage	mV/°C		-4.0	
ESD Classification (HBM per Mil-Std-883D)			Class 2	
DC Forward Current	mA			500
Reverse Voltage	V			5
Forward Voltage (@ 125 mA)	V		3.2	
Forward Voltage (@ 350 mA)	V		3.5	4.0
Forward Voltage (@ 500 mA)	V		3.6	
LED Junction Temperature	°C			145
Operating Temperature	°C	-40		85



Relative Spectral Power

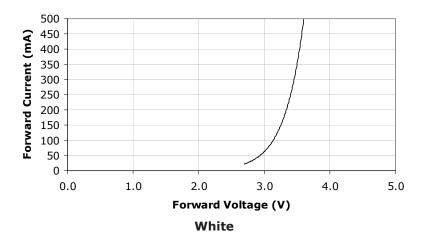


Photometric Output vs. Junction Temperature ($I_F = 350 \text{ mA}$)



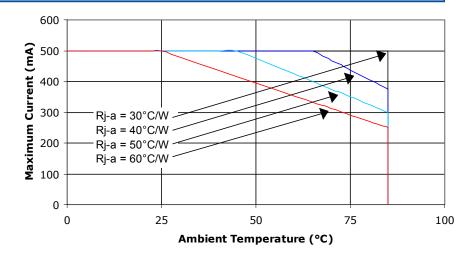


Electrical Characteristics $(T_1 = 25^{\circ}C)$



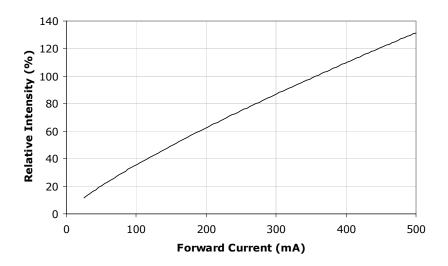
Thermal Design

The maximum forward current is determined by the thermal resistance between the LED junction and ambient. Given an existing thermal resistance of 12°C/W between the junction and the solder point, it is crucial for the end product to be designed in a manner that minimizes the thermal resistance from the solder point to ambient in order to optimize lamp life and optical characteristics.

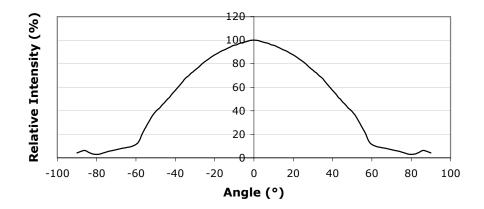




Relative Intensity vs. Current $(T_1 = 25^{\circ}C)$



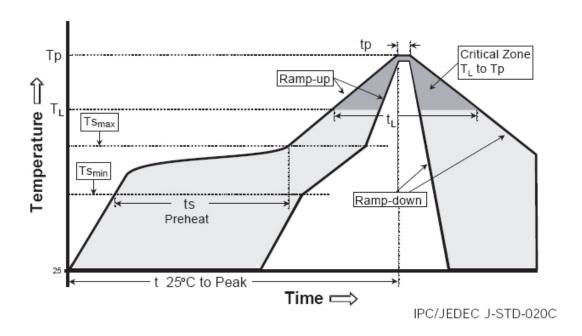
Typical Spatial Radiation Pattern





Reflow Soldering Characteristics

The following reflow soldering profiles are provided for reference. Cree recommends that users follow the recommended soldering profile provided by the manufacturer of the solder paste used. Cree XLamp LEDs are compatible with JEDEC J-STD-020C.



Profile Feature	Lead-Based Solder	Lead-Free Solder	
Average Ramp-Up Rate (Ts _{max} to Tp)	3°C/second max.	3°C/second max.	
Preheat: Temperature Min (Ts _{min})	100°C	150°C	
Preheat: Temperature Max (Ts _{max})	150°C	200°C	
Preheat: Time (ts _{min} to ts _{max})	60-120 seconds	60-180 seconds	
Time Maintained Above: Temperature (T _L)	183°C	217°C	
Time Maintained Above: Time (t_L)	60-150 seconds	60-150 seconds	
Peak/Classification Temperature (Tp)	215°C	260°C	
Time Within 5°C of Actual Peak Temperature (tp)	10-30 seconds	20-40 seconds	
Ramp-Down Rate	6°C/second max.	6°C/second max	
Time 25°C to Peak Temperature	6 minutes max.	8 minutes max.	

Note: All temperatures refer to topside of the package, measured on the package body surface.



Notes

Lumen Maintenance Projections

Based on internal long-term reliability testing and standardized forecasting methods, Cree projects XLamp LEDs to maintain an average of 70% lumen maintenance after 50,000 hours, provided the LED junction temperature is maintained at or below 80°C.

Please read the XLamp Reliability application note for more details on Cree's lumen maintenance testing and forecasting. Please read the XLamp Thermal Management application note for details on how thermal design, ambient temperature, and drive current affect the LED junction temperature.

Moisture Sensitivity

XLamp LEDs are shipped in sealed, moisture-barrier bags (MBB) designed for long shelf life. If XLamp LEDs are exposed to moist environments after opening the MBB packaging but before soldering, damage to the LED may occur during the soldering operation. The following derating table defines the maximum exposure time (in days) for an XLamp LED in the listed humidity and temperature conditions. LEDs with exposure time longer than the time specified below must be baked according to the baking conditions listed below.

Tomoroustino	Maximum Percent Relative Humidity						
Temperature	30%	40%	50%	60%	70%	80%	90%
30°C	9	5	4	3	1	1	1
25°C	12	7	5	4	2	1	1
20°C	17	9	7	6	2	2	1

Baking Conditions

It is not necessary to bake all XLamp LEDs. Only the LEDs that meet all of the following criteria must be baked:

- 1. LEDs that have been removed from the original MBB packaging
- 2. LEDs that have been exposed to a humid environment longer than listed in the Moisture Sensitivity section above
- 3. LEDs that have not been soldered

LEDs should be baked at 80°C for 24 hours. LEDs may be baked on the original reels. Remove LEDs from MBB packaging before baking. Do not bake parts at temperatures higher than 80°C. This baking operation resets the exposure time as defined in the Moisture Sensitivity section above.

Storage Conditions

XLamp LEDs that have been removed from original MBB packaging but not soldered yet should be stored in a room or cabinet that will maintain an atmosphere of $25 \pm 5^{\circ}$ C and no greater than 10% RH (relative humidity). For LEDs stored in these conditions, storage time does not add to exposure time as defined in the Moisture Sensitivity section above.

RoHS Compliance

The levels of environmentally sensitive, persistent biologically toxic (PBT), persistent organic pollutants (POP), or otherwise restricted materials in this product are below the maximum concentration values (also referred to as the threshold limits) permitted for such substances, or are used in an exempted application, in accordance with EU Directive 2002/95/EC on the restriction of the use of certain hazardous substances in electrical and electronic equipment (RoHS), as amended through April 21, 2006.

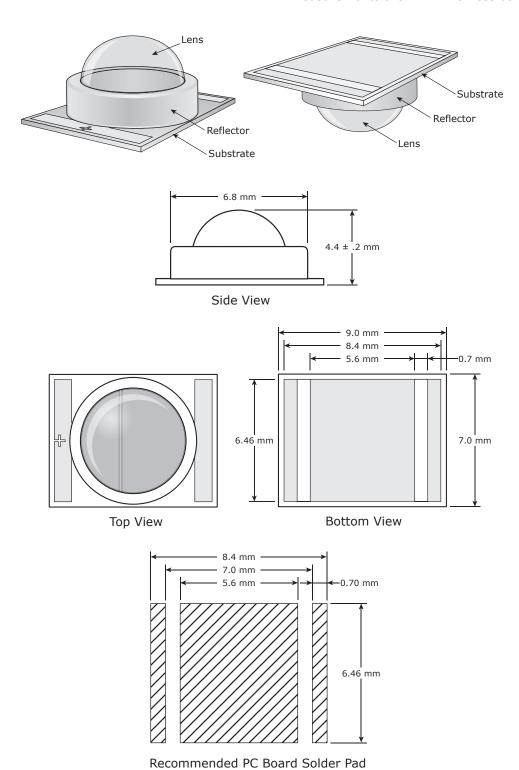
Vision Advisory Claim

Users should be cautioned not to stare at the light of this LED product. The bright light can damage the eye.



Mechanical Dimensions ($T_A = 25$ °C)

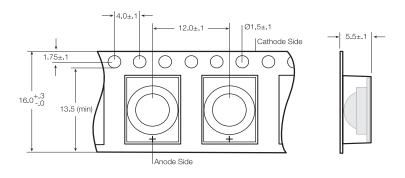
All measurements are $\pm .1$ mm unless otherwise indicated.

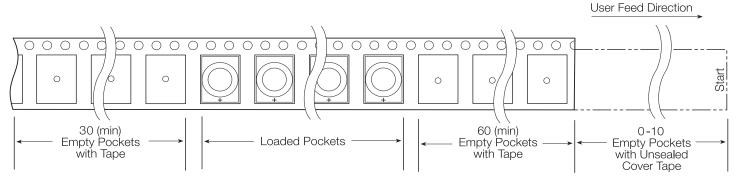


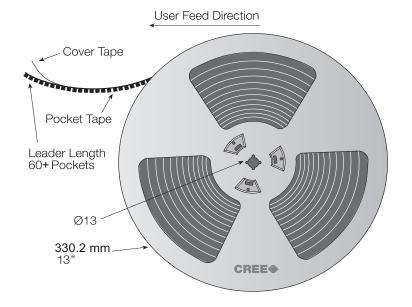


Tape and Reel

All dimensions in mm.









Dry Packaging and Packaging

